



BC817-16 / -25 / -40

NPN SURFACE MOUNT SMALL SIGNAL TRANSISTOR

Features

- Ideally Suited for Automated Insertion
- **Epitaxial Planar Die Construction**
- For Switching, AF Driver and Amplifier Applications
- Complementary PNP Types Available (BC807)
- Lead, Halogen and Antimony Free, RoHS Compliant
- "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound, • Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Pin Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)



Top View

Device Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	45	V
Emitter-Base Voltage	V _{EBO}	5.0	V
Collector Current	lc	800	mA
Peak Collector Current	Ісм	1000	mA
Peak Emitter Current	I _{EM}	1000	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation at $T_{SB} = 50^{\circ}C$ (Note 1)	PD	310	mW
Thermal Resistance, Junction to Substrate Backside (Note 1)	$R_{\theta SB}$	320	°C/W
Thermal Resistance, Junction to Ambient Air (Note 1)	R _{θJA}	403	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Character	Symbol	Min	Max	Unit	Test Condition		
	Current Gain Group -16 -25 -40		100 160 250	250 400 600	_	V _{CE} = 1.0V, I _C = 100mA	
DC Current Gain	Current Gain Group -16 -25 -40	h _{FE}	60 100 170		_	V _{CE} = 1.0V, I _C = 300mA	
Collector-Emitter Saturation	V _{CE(SAT)}		0.7	V	$I_{\rm C} = 500 {\rm mA}, I_{\rm B} = 50 {\rm mA}$		
Base-Emitter Voltage		V_{BE}		1.2	V	$V_{CE} = 1.0V, I_{C} = 300mA$	
Collector-Emitter Cutoff Curr	I _{CES}		100 5.0	nA μA	V _{CE} = 45V V _{CE} = 25V, T _i = 150°C		
Emitter-Base Cutoff Current	I _{EBO}	_	100	nA	$V_{EB} = 4.0V$		
Gain Bandwidth Product	fT	100	—	MHz	$V_{CE} = 5.0V, I_{C} = 10mA, f = 50MHz$		
Collector-Base Capacitance	C _{CBO}	_	12	pF	$V_{CB} = 10V, f = 1.0MHz$		

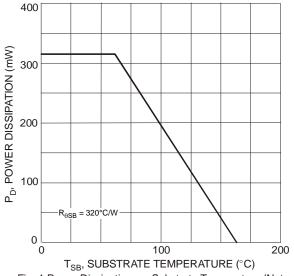
1. Device mounted on Ceramic Substrate 0.7mm; 2.5cm² area. Notes:

2. Short duration pulse test used to minimize self-heating effect.

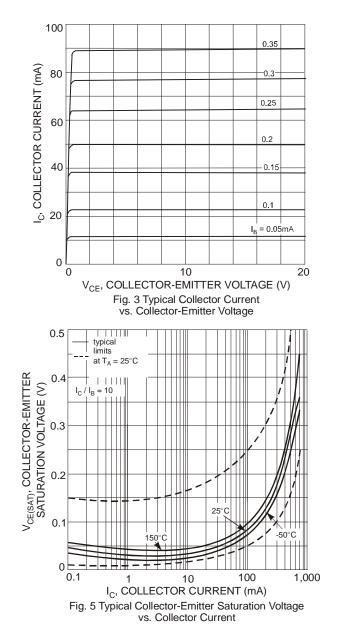
3.

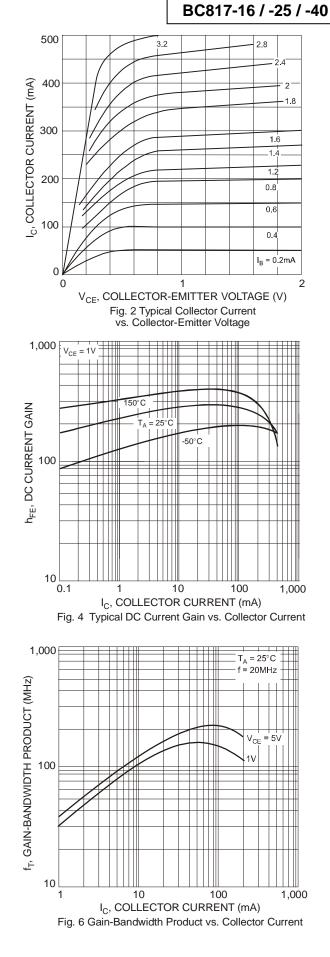
No purposefully added lead. Halogen and Antimony Free. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 4. V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.













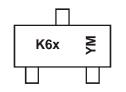
Ordering Information (Note 5)

Part Number	Case	Packaging
BC817-xx-7-F	SOT-23	3000/Tape & Reel

*xx = gain group, e.g. BC817-16-7-F.

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

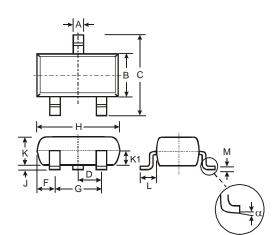


K6x = Product Type Marking Code: K6A = BC817-16 K6B = BC817-25 K6C = BC817-40 YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

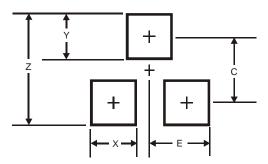
Date Code R	ey																	
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	J	K	L	Μ	Ν	Р	R	S	Т	U	V	W	Х	Y	Z	Α	В	С
Month	Jan	1	Feb	Ma	r	Apr	May	У	Jun	Ju		Aug	Sep)	Oct	Nov	'	Dec
Code	1		2	3		4	5		6	7		8	9		0	N		D

Package Outline Dimensions



SOT-23							
Dim	Min	Max	Тур				
Α	0.37	0.40					
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
Κ	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	-				
All	Dimens	ions in	mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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